



Docket No.: 3749-0106PUS1  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Hiroyuki OSADA et al.

Application No.: 10/551,809

Art Unit: 1744

Filed: September 30, 2005

Examiner: Not Yet Assigned

For: METHOD OF FIXING LOW-MOLECULAR  
COMPOUND TO SOLID-PHASE SUPPORT

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**SECOND PRELIMINARY AMENDMENT**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**INTRODUCTORY COMMENTS**

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

This amendment includes:

**Amendments to the Specification** begin on page 2 of this paper.

**Remarks/Arguments** begin on page 3 of this paper.